

## **MPM3620A**

## 24 V/2 A DC/DC Module Synchronous Step-Down Converter with Integrated Inductor

#### **DESCRIPTION**

The MPM3620A is a synchronous, rectified, step-down module converter with an integrated inductor, two capacitors, and power MOSFETs. It offers a compact solution that requires only 5 external components to achieve a 2 A continuous output current with excellent load and line regulation over a wide input-supply range. Also, it provides fast load transient response.

Full protection features include over-current protection (OCP) and thermal shutdown (TSD).

MPM3620A eliminates design and manufacturing risks while dramatically improving time-to-market.

The MPM3620A is available in a space-saving QFN20 (3mm x 5mm x 1.6mm) package.

#### **FEATURES**

- 4.5 V to 24 V Operating Input Range
- 2 A Continuous Load Current
- 90 mΩ/40 mΩ Low R<sub>DS(ON)</sub> Internal Power MOSFETs
- Integrated Inductor
- Integrated VCC and Bootstrap Capacitors
- Power-Save Mode at Light Load
- Power Good Indicator
- Over-Current Protection and Hiccup
- Thermal Shutdown
- Output Adjustable from 0.8 V
- Available in QFN20 (3mm x 5mm x 1.6mm) Package
- Total Solution Size 6.7mm x 7.3mm

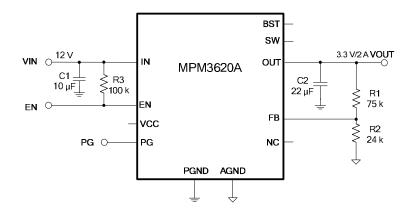
#### **APPLICATIONS**

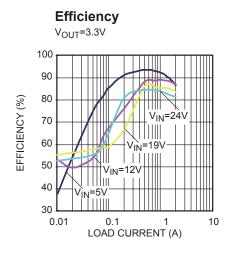
- Industrial Controls
- Medical and Imaging Equipment
- Telecom and Networking Applications
- LDO Replacement
- Space and Resource-Limited Applications

All MPS parts are lead-free, halogen-free, and adhere to the RoHS directive. For MPS green status, please visit the MPS website under Quality Assurance.

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#### TYPICAL APPLICATION





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#### ORDERING INFORMATION

| Part Number* | Package                    | Top Marking |
|--------------|----------------------------|-------------|
| MPM3620AGQV  | QFN-20 (3mm x 5mm x 1.6mm) | See Below   |

<sup>\*</sup> For Tape & Reel, add suffix -Z (e.g. MPM3620AGQ-Z);

#### **TOP MARKING**

<u>MPYW</u>

<u>3</u>620

ALLL

M

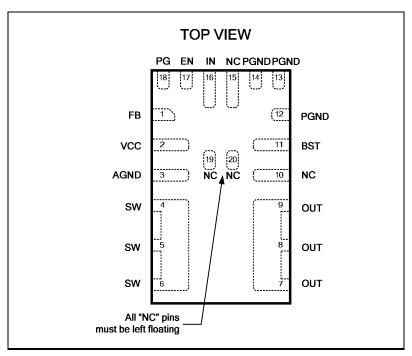
MP: MPS prefix Y: Year code W: Week code

3620A: Product code of MPM3620AGQV

LLL: Lot number

M: Module

## **PACKAGE REFERENCE**





## ABSOLUTE MAXIMUM RATINGS (1) V<sub>IN</sub> .....-0.3 V to 28 V V<sub>OUT</sub> .....-0.3 V to 28 V V<sub>SW</sub> ..... -0.3 V (-5 V for <10 ns) to 28 V (30 V for V<sub>BST</sub> ......V<sub>SW</sub>+6 V All other pins.....-0.3 V to 6 V (2) Continuous power dissipation ( $T_A = +25^{\circ}C$ ) (3) .....2.7 W Storage temperature.....-65°C to 150°C Recommended Operating Conditions (4) Supply voltage (V<sub>IN</sub>) ...... 4.5 V to 24 V Output voltage $(V_{OUT})$ .................................. 0.8 V to $V_{IN}*D_{MAX}^{(5)}$ Operating junction temp. (T<sub>J</sub>)...-40°C to +125°C

Thermal Resistance (6)  $\theta_{JC}$ QFN-20 (3mm x 5mm x 1.6mm) 46..... 10... °C/W

#### NOTES:

- 1) Exceeding these ratings may damage the device.
- For additional details on EN's absolute max. rating, please refer to the "Enable Control" section on page 15.
- The maximum allowable power dissipation is a function of the maximum junction temperature T<sub>J</sub> (MAX), the junction-toambient thermal resistance  $\theta_{\text{JA}}$ , and the ambient temperature T<sub>A</sub>. The maximum allowable continuous power dissipation at any ambient temperature is calculated by  $P_D$  (MAX) =  $(T_J)$ (MAX)-T<sub>A</sub>)/θ<sub>JA</sub>. Exceeding the maximum allowable power dissipation produces an excessive die temperature, causing the converter to go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- The device is not guaranteed to function outside of its operating conditions.
- In practical design, the minimum  $V_{\text{OUT}}$  is limited by the minimum on-time. To allow a margin, a 50 ns on-time is recommended for calculating. To set the output voltage above 5.5 V, please refer to the application information on page 18.

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Measured on JESD51-7, 4-layer PCB.



### **ELECTRICAL CHARACTERISTICS**

V<sub>IN</sub>=12 V, T<sub>J</sub>=-40°C to +125°C<sup>(7)</sup>, typical value is tested at T<sub>J</sub>=+25°C, unless otherwise noted.

| Parameter                                     | Symbol                    | lue is tested at T <sub>J</sub> =+25°C, unles<br>Condition                 | Min  |      |      | Units           |
|---|---------------------------|--|------|------|------|-----------------|
| Parameter                                     | Symbol                    |  | WIIN | Тур  | Max  |                 |
| Supply current (shutdown)                     | l <sub>s</sub>            | V <sub>EN</sub> = 0 V, T <sub>J</sub> =+25°C                               |      | 6.5  | 8    | μA              |
|   | -                         | V <sub>EN</sub> = 0 V, T <sub>J</sub> =-40°C to +125°C                     |      | 6.5  | 9    | μA              |
| Supply current (quiescent)                    | l <sub>q</sub>            | V <sub>FB</sub> = 1 V, T <sub>J</sub> =+25°C                               |      | 0.3  | 0.39 | mA              |
|   |                           | $V_{FB} = 1 \text{ V}, T_J = -40^{\circ}\text{C to } +125^{\circ}\text{C}$ |      | 0.3  | 0.44 | mA              |
| HS switch-on resistance                       | HS <sub>RDS-ON</sub>      | V <sub>BST-SW</sub> =5 V   |      | 90   |      | mΩ              |
| LS switch-on resistance                       | LS <sub>RDS-ON</sub>      | V <sub>CC</sub> =5 V   |      | 40   |      | mΩ              |
| Integrated inductor inductance <sup>(8)</sup> | L                         |  |      | 1    |      | μH              |
| Inductor DC resistance                        | L <sub>DCR</sub>          | T <sub>J</sub> =25°C   | 25   | 45   | 65   | mΩ              |
| Switch leakage                                | SW <sub>LKG</sub>         | V <sub>EN</sub> = 0 V, V <sub>SW</sub> =12 V                               |      |      | 1    | μΑ              |
| Current limit <sup>(8)</sup>                  | I <sub>LIMIT</sub>        | Under 40% duty cycle   | 3.15 | 4.25 |      | Α               |
| Oscillator frequency                          | f <sub>SW</sub>           | V <sub>FB</sub> =0.75 V, T <sub>J</sub> =+25°C                             | 1600 | 2000 | 2400 | kHz             |
| - Coomator requeries                          | 1500                      | $V_{FB}$ =0.75 V, $T_J$ =-40°C to +125°C                                   | 1500 | 2000 | 2500 | kHz             |
| Foldback frequency                            | f <sub>FB</sub>           | V <sub>FB</sub> =200 mV  |      | 0.3  |      | $f_{\text{SW}}$ |
|   |                           | $V_{FB}$ =700 mV, $T_J$ =+25°C   | 78   | 83   | 88   | %               |
| Maximum duty cycle                            | $D_{MAX}$                 | $V_{FB}$ =700 mV, $T_J$ =-40°C to +125°C                                   | 77   | 83   | 89   | %               |
| Minimum on time <sup>(8)</sup>                | T <sub>ON_MIN</sub>       |  |      | 30   |      | ns              |
| Foodle calcustions                            |                           | T <sub>J</sub> =25°C   | 786  | 798  | 810  | mV              |
| Feedback voltage                              | $V_{FB}$                  | T <sub>J</sub> =-40°C to +125°C  | 782  | 798  | 814  | mV              |
| Feedback current                              | $I_{FB}$ $V_{FB}$ =820 mV |  |      | 10   | 50   | nA              |
| EN rising threshold                           | Ven_rising                | T <sub>J</sub> =+25°C  | 1.2  | 1.4  | 1.6  | V               |
| LIVIIIIIII IIIIESIIOIU                        | V EN_RISING               | T <sub>J</sub> =-40°C to +125°C  | 1.15 | 1.4  | 1.65 | V               |
| EN falling threshold                          | Ven_falling               | T <sub>J</sub> =+25°C  | 1.05 | 1.25 | 1.4  | V               |
| ETV Tunning time smooth                       | V LIV_I ALLING            | T <sub>J</sub> =-40°C to +125°C  | 1    | 1.25 | 1.45 | V               |
| EN input current                              | Ien                       | V <sub>EN</sub> =2 V, T <sub>J</sub> =+25°C                                | 2    | 2.3  | 2.6  | μA              |
|   | 12.1                      | V <sub>EN</sub> =2 V, T <sub>J</sub> =-40°C to +125°C                      | 1.8  | 2.3  | 2.8  | μA              |
| Power good rising threshold                   | PG <sub>VTH-Hi</sub>      | T <sub>J</sub> =+25°C  | 0.86 | 0.9  | 0.95 | $V_{FB}$        |
| Power good falling threshold                  | PG <sub>VTH-LO</sub>      | T <sub>J</sub> =+25°C  | 0.78 | 0.83 | 0.88 | $V_{FB}$        |
| Power good rising delay                       | PG <sub>TD_RSING</sub>    | T <sub>J</sub> =+25°C  | 15   | 35   | 55   | μs              |
| Tower good fishing delay                      | 1 OTD_RSING               | $T_{\rm J}$ =-40°C to +125°C   | 10   | 35   | 60   | μs              |
| Power good falling delay                      | PG <sub>TD_FALLING</sub>  | T <sub>J</sub> =+25°C  | 40   | 80   | 125  | μs              |
| 1 ower good raining delay                     | r Old_FALLING             | $T_{\rm J}$ =-40°C to +125°C   | 30   | 80   | 135  | μs              |
| Power good sink current capability            | $V_{PG}$                  | Sink 1 mA  |      |      | 0.4  | V               |
| Power good leakage current                    | I <sub>PG-LEAK</sub>      | V <sub>PG</sub> =6 V   |      |      | 1    | μΑ              |
|   |                           |  | _    |      | _    |                 |



## **ELECTRICAL CHARACTERISTICS (CONTINUED)**

V<sub>IN</sub>=12 V, T<sub>J</sub>=-40°C to +125°C, typical value is tested at T<sub>J</sub>=+25°C, unless otherwise noted.

| Parameter                                      | Symbol              | Condition   | Min  | Тур | Max  | Units |  |
|--|---------------------|---|------|-----|------|-------|--|
| VIN under-voltage lockout                      | INILIN/             | T <sub>J</sub> =+25°C                             | 3.7  | 3.9 | 4.1  | V     |  |
| threshold—rising                               | $INUV_{Vth}$        | T <sub>J</sub> =-40°C to +125°C                   | 3.65 | 3.9 | 4.15 | V     |  |
| VIN under-voltage lockout threshold—hysteresis |                     |   | 600  | 675 | 750  | mV    |  |
| VCC regulator                                  | \/                  | T <sub>J</sub> =+25°C                             | 4.75 | 4.9 | 5.05 | V     |  |
| VCC regulator                                  | V <sub>CC</sub>     | T <sub>J</sub> =-40°C to +125°C                   | 4.7  | 4.9 | 5.1  | V     |  |
| VCC load regulation                            |                     | I <sub>CC</sub> =5 mA                             |      | 1.5 | 3    | %     |  |
|  |                     | $V_{OUT}$ from 10% to 90%, $T_J = +25$ °C         | 8.0  | 1.6 | 2.4  | ms    |  |
| Soft-start time                                | t <sub>SS</sub>     | $V_{OUT}$ from 10% to 90%, $T_J$ =-40°C to +125°C | 0.6  | 1.6 | 2.6  | ms    |  |
| Thermal shutdown (8)                           | T <sub>SD</sub>     |   |      | 150 |      | °C    |  |
| Thermal hysteresis (8)                         | T <sub>SD HYS</sub> |   |      | 20  |      | °C    |  |

#### NOTES:

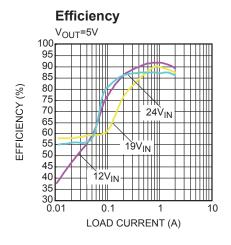
<sup>7)</sup> Not tested in production. Guaranteed by over-temperature correlation.

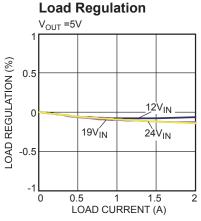
<sup>8)</sup> Guaranteed by characterization test.

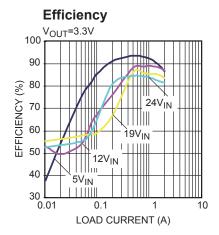


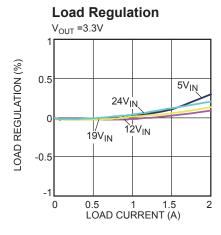
### TYPICAL CHARACTERISTICS

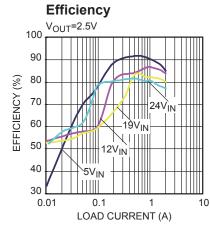
 $V_{IN}$  = 12 V,  $V_{OUT}$  = 3.3 V,  $T_A$  = 25°C, unless otherwise noted.

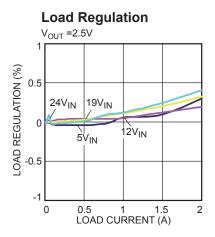


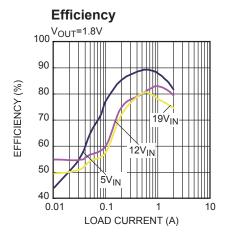


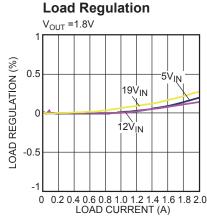


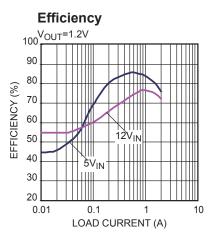








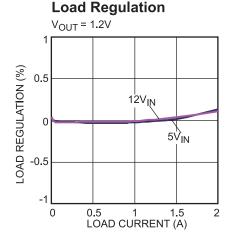


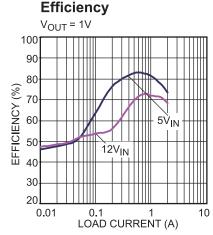


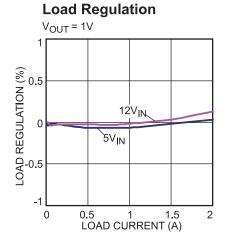


## TYPICAL CHARACTERISTICS (continued)

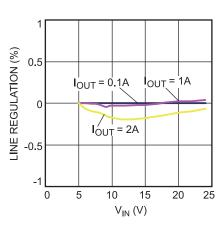
 $V_{\text{IN}}$  = 12 V,  $V_{\text{OUT}}$  = 3.3 V,  $T_{\text{A}}$  = 25°C, unless otherwise noted.



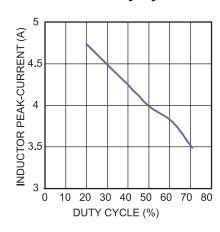




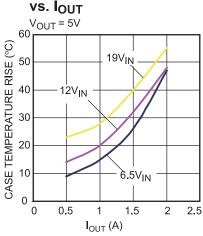
Line Regulation V<sub>OUT</sub> = 3.3V



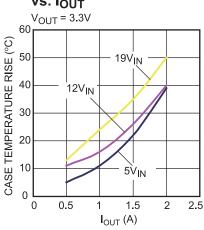
Inductor Peak Current Limit vs. Duty Cycle



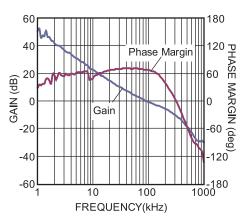
Case Temperature Rise



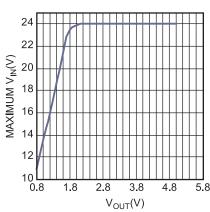
Case Temperature Rise vs. I<sub>OUT</sub>



Bode Plot I<sub>OUT</sub> = 2A



#### Maximum V<sub>IN</sub> vs. V<sub>OUT</sub>

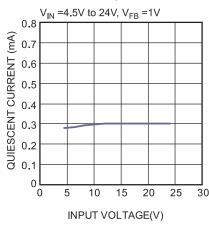




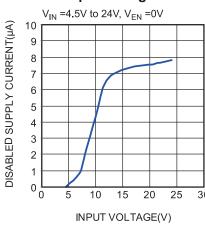
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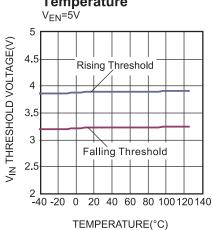
# Quiescent Current vs. Input Voltage



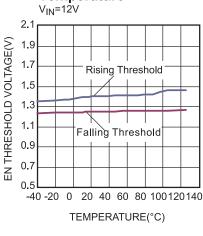
# Disabled Supply Current vs. Input Voltage



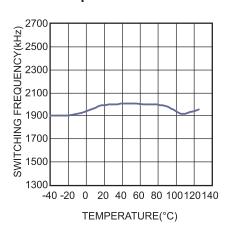
## VIN Threshold vs. Temperature



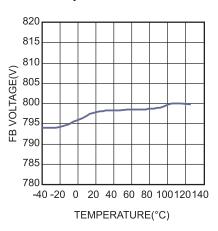
## EN Threshold vs. Temperature



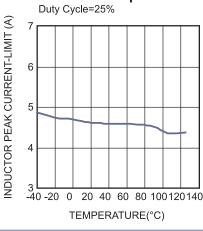
## Switching Frequency vs. Temperature



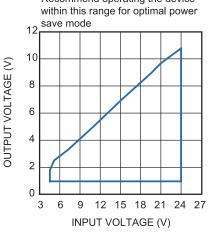
FB Voltage vs. Temperature



# Inductor Peak Current Limit vs. Temperature



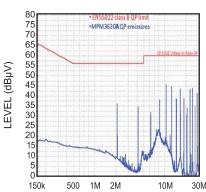
#### Power-Save Mode Range Recommend operating the device



#### **Conduction-EMI**

C<sub>IN</sub>=64µF+10nF/0402

I<sub>OUT</sub>=2A



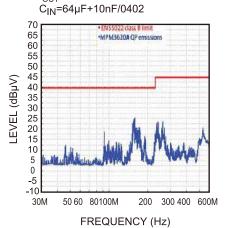
FREQUENCY (Hz)



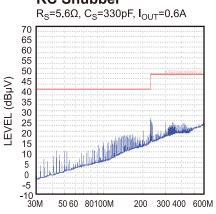
## TYPICAL CHARACTERISTICS (continued)

 $V_{IN}$  = 12V,  $V_{OUT}$  = 3.3V,  $T_A$  = 25°C, unless otherwise noted.

# Radiated EMI



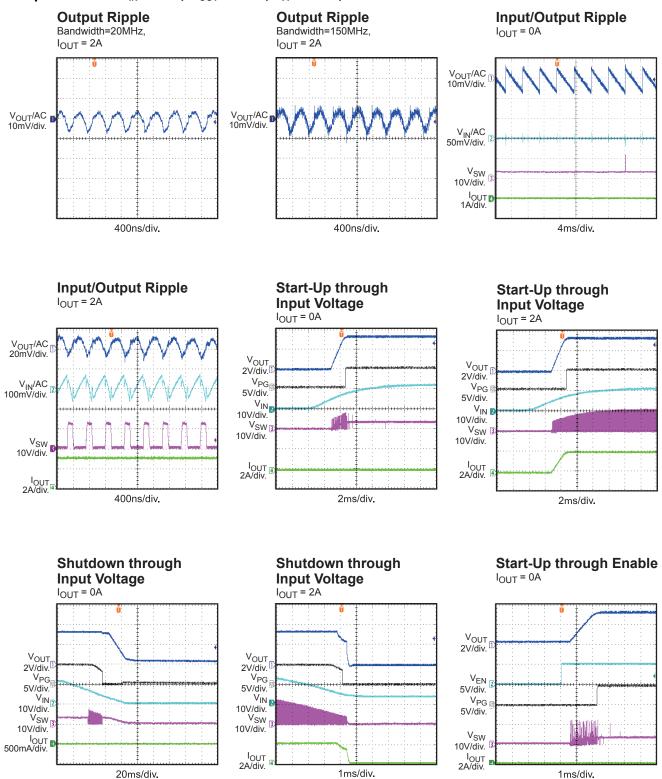
## Radiated EMI with RC Snubber





#### TYPICAL PERFORMANCE CHARACTERISTICS

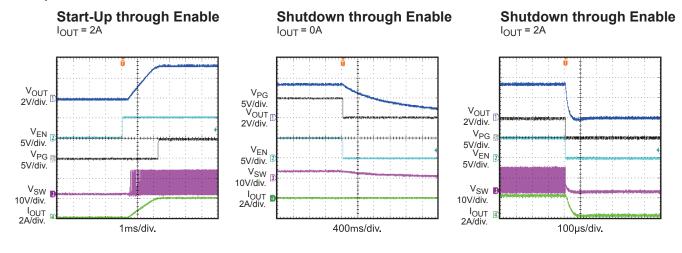
Performance waveforms are captured from the evaluation board discussed in the Design Example section.  $V_{IN} = 12V$ ,  $V_{OUT} = 3.3V$ ,  $T_A = 25$ °C, unless otherwise noted.

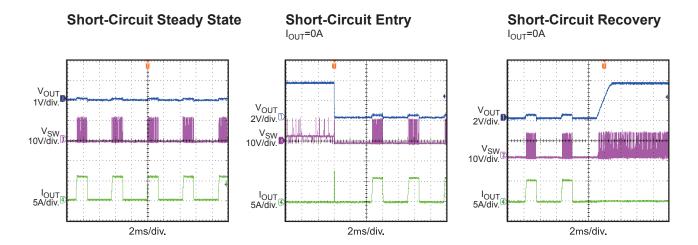


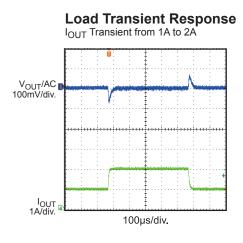


## TYPICAL PERFORMANCE CHARACTERISTICS (continued)

Performance waveforms are captured from the evaluation board discussed in the Design Example section.  $V_{IN} = 12V$ ,  $V_{OUT} = 3.3V$ ,  $T_A = 25$ °C, unless otherwise noted.









## **PIN FUNCTIONS**

| Package<br>Pin #  | Name | Description   |
|-------------------|------|---|
| 1                 | FB   | <b>Feedback.</b> Connect FB to the tap of an external resistor divider from the output to AGND to set the output voltage. To prevent current-limit runaway during a short-circuit fault, the frequency foldback comparator lowers the oscillator frequency when the FB voltage is below 400 mV. Place the resistor divider as close to FB as possible. Avoid placing vias on the FB traces. |
| 2                 | VCC  | <b>Internal 4.9 V LDO output.</b> The module integrates a LDO output capacitor, so there is no need to add an external capacitor.   |
| 3                 | AGND | <b>Analog ground.</b> AGND is the reference ground of the logic circuit. AGND is connected internally to PGND, so there is no need to add any external connections to PGND.   |
| 4, 5, 6           | SW   | <b>Switch output.</b> A large copper plane is recommended on pins 4, 5, and 6 to improve thermal performance.   |
| 7, 8, 9           | OUT  | Power output. Connect the load to OUT. An output capacitor is needed.   |
| 10, 15,<br>19, 20 | NC   | DO NOT CONNECT. NC must be left floating.   |
| 11                | BST  | <b>Bootstrap.</b> A bootstrap capacitor is integrated internally, so an external connection is not needed.  |
| 12, 13, 14        | PGND | <b>Power ground</b> . PGND is the reference ground of the power device. PCB layout requires extra care, please refer to the "PCB Layout Guidelines" section on page 19. For best results, connect to PGND with copper and vias.   |
| 16                | IN   | <b>Supply voltage.</b> IN supplies power to the internal MOSFET and regulator. The MPM3620A operates from a +4.5 V to +24 V input rail. It requires a low ESR and low-inductance capacitor to decouple the input rail. Place the input capacitor very close to IN and connect it with wide PCB traces and multiple vias.  |
| 17                | EN   | <b>Enable.</b> Pull EN high to enable the module. Leave EN floating or connect it to GND to disable the module.   |
| 18                | PG   | <b>Power good indicator.</b> PG is an open-drain output. Connect PG to VCC (or another voltage source) through a pull-up resistor (e.g. 100 k $\Omega$ ). For additional details, please refer to the "Power Good Indicator" section on page 15.  |



### **FUNCTIONAL BLOCK DIAGRAM**

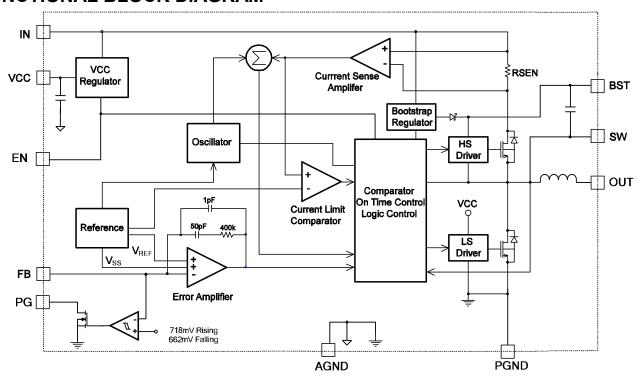


Figure 1—Functional block diagram

#### **OPERATION**

The MPM3620A is a high-frequency, synchronous, rectified, step-down, switch-mode converter with an integrated inductor, two capacitors, and power MOSFETs. It offers a compact solution that achieves a 2 A continuous output current with excellent load and line regulation over a 4.5 V to 24 V inputsupply range.

The MPM3620A has three working modes: advanced asynchronous modulation (AAM), similar to PFM mode, discontinuous conduction mode (DCM), and continuous conduction mode (CCM). The load current increases as the device transitions from AAM mode to DCM to CCM. In particular conditions, the device will not enter AAM mode during a light-load condition (see the Power-Save Mode Range graph on page 8).

#### **AAM Control Operation**

In a light-load condition, the MPM3620A operates in AAM mode (see Figure 2). The  $V_{\text{AAM}}$  is an internally fixed voltage when input and output voltages are fixed.  $V_{\text{COMP}}$  is the error amplifier output, which represents the peak inductor current information. When  $V_{\text{COMP}}$  is lower than  $V_{\text{AAM}}$ , the internal clock is blocked. This causes the MPM3620A to skip pulses, achieving the light-load power save. Refer to AN032 for additional details.

The internal clock re-sets every time  $V_{\text{COMP}}$  exceeds  $V_{\text{AAM}}$ . Simultaneously, the high-side MOSFET (HS-FET) turns on and remains on until  $V_{\text{ILsense}}$  reaches the value set by  $V_{\text{COMP}}$ .

The light-load feature in this device is optimized for 12 V input applications.

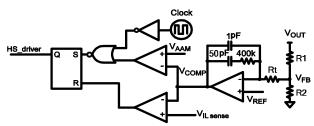


Figure 2—Simplified AAM control logic

#### **DCM Control Operation**

The  $V_{\text{COMP}}$  ramps up as the output current increases. When its minimum value exceeds  $V_{\text{AAM}}$ , the device enters DCM. In this mode, the internal 2 MHz clock initiates the PWM cycle, the HS-FET turns on and remains on until  $V_{\text{ILsense}}$  reaches the value set by  $V_{\text{COMP}}$  (after a period of dead time), and then the low-side MOSFET (LS-FET) turns on and remains on until the inductor-current value decreases to zero. The device repeats the same operation in every clock cycle to regulate the output voltage (see Figure 3).

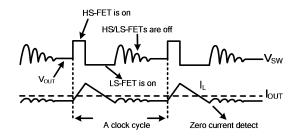


Figure 3—DCM control operation

#### **CCM Control Operation**

The device enters CCM from DCM once the inductor current no longer drops to zero in a clock cycle. In CCM, the internal 2 MHz clock initiates the PWM cycle, the HS-FET turns on and remains on until  $V_{\text{ILsense}}$  reaches the value set by  $V_{\text{COMP}}$  (after a period of dead time), and then the LS-FET turns on and remains on until the next clock cycle begins. The device repeats the same operation in every clock cycle to regulate the output voltage.

If  $V_{\text{ILsense}}$  does not reach the value set by  $V_{\text{COMP}}$  within 83% of one PWM period, the HS-FET will be forced off.

#### Internal V<sub>cc</sub> Regulator

A 4.9 V internal regulator powers most of the internal circuitries. This regulator takes  $V_{\text{IN}}$  and operates in the full  $V_{\text{IN}}$  range. When  $V_{\text{IN}}$  exceeds 4.9 V, the output of the regulator is in full regulation. If  $V_{\text{IN}}$  is less than 4.9 V, the output decreases. The device integrates an internal decoupling capacitor, so adding an external VCC output capacitor is unnecessary.



#### Error Amplifier (EA)

The error amplifier compares the FB voltage to the internal 0.798 V reference ( $V_{REF}$ ) and outputs a current proportional to the difference between the two. This output current then charges or discharges the internal compensation network to form the COMP voltage; the COMP voltage controls the power MOSFET current. The optimized internal compensation network minimizes the external component count and simplifies control loop design.

#### **Under-Voltage Lockout (UVLO)**

Under-voltage lockout (UVLO) protects the chip from operating at an insufficient input-supply voltage. The MPM3620A UVLO comparator monitors the output voltage of the internal regulator (VCC). The UVLO rising threshold is about 3.9 V while its falling threshold is 3.225 V.

#### **Enable Control (EN)**

EN turns the converter on and off. Drive EN high to turn on the converter; drive EN low to turn off the converter. An internal 870 k $\Omega$  resistor from EN to GND allows EN to be floated to shut down the chip.

EN is clamped internally using a 6.5 V series-Zener diode (see Figure 4). Connecting EN to a voltage source directly without a pull-up resistor requires limiting the amplitude of the voltage source to ≤6 V to prevent damage to the Zener diode.

Connecting the EN input through a pull-up resistor to the voltage on  $V_{\text{IN}}$  limits the EN input current to less than 100  $\mu$ A.

For example, with 12 V connected to  $V_{IN}$ ,  $R_{PULLUP} \ge (12 \text{ V} - 6.5 \text{ V}) \div 100 \ \mu\text{A} = 55 \ \text{k}\Omega$ .

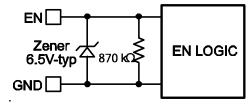


Figure 4—6.5V Zener diode connection

#### Internal Soft-Start (SS)

Soft-start prevents the converter output voltage from overshooting during start-up. When the chip starts up, the internal circuitry generates a soft-start voltage (SS) that ramps up from 0 V to 4.9 V. When SS is lower than  $V_{REF}$ , the error amplifier uses SS as the reference. When SS is higher than  $V_{REF}$ , the error amplifier uses  $V_{REF}$  as the reference. The SS time is set internally to 1.6 ms ( $V_{OUT}$  from 10% to 90%).

#### **Pre-Bias Start-Up**

The MPM3620A is designed for a monotonic start-up into a pre-biased output voltage. If the output is pre-biased to a certain voltage during start-up,  $V_{\rm SS}$  ramps up. When  $V_{\rm SS}$  exceeds the sensed output voltage at FB, the device turns on the HS-FET and the LS-FET sequentially. The output voltage ramps up following the internal SS slew rate.

#### **Power Good Indicator (PG)**

The MPM3620A has power good (PG) output to indicate whether the output voltage of the module is ready. PG is an open-drain output. Connect PG to VCC (or another voltage source) through a pull-up resistor (e.g. 100 k $\Omega$ ). When the input voltage is applied, PG is pulled down to GND before the internal V<sub>SS</sub>>1 V. Once V<sub>SS</sub>>1 V (when V<sub>FB</sub> is above 90% of V<sub>REF</sub>), PG is pulled high (after a 35 µs delay). During normal operation, PG is pulled low when the V<sub>FB</sub> drops below 83% of V<sub>REF</sub> (after an 80µs delay).

When UVLO or OTP occurs, PG is pulled low immediately; when OC (over-current) occurs, PG is pulled low when  $V_{FB}$  drops below 83% of  $V_{RFF}$  (after an 80µs delay).

Since MPM3620A doesn't implement dedicated output over-voltage protection, PG will not respond to an output over-voltage condition.

#### **Over-Current Protection and Hiccup (OCP)**

The MPM3620A has a cycle-by-cycle over-current limiting control. When the inductor current peak value exceeds the internal peak current-limit threshold, the HS-FET turns off and the LS-FET turns on, remaining on until the inductor current falls below the internal valley current-limit threshold. The valley current-limit circuit decreases the operation frequency (after the peak current-limit threshold is triggered). Meanwhile, the output voltage drops until  $V_{FB}$  is below the under-voltage (UV) threshold (50% below the reference, typically).

Once UV is triggered, the MPM3620A enters hiccup mode to re-start the part periodically. This protection mode is useful when the output is dead-shorted to ground and greatly reduces the average short-circuit current to alleviate thermal issues and protect the converter. The MPM3620A exits hiccup mode once the overcurrent condition is removed.

#### Thermal Shutdown (TSD)

To prevent thermal damage, MPM3620A stops switching when the die temperature exceeds 150°C. As soon as the temperature drops below its lower threshold (130°C, typically), the power supply resumes operation.

#### Floating Driver and Bootstrap Charging

An internal bootstrap capacitor powers the floating power MOSFET driver. This floating driver has its own UVLO protection. This UVLO's rising threshold is 2.2 V with a hysteresis of 150 mV. The bootstrap capacitor voltage is regulated internally by  $V_{\text{IN}}$  through D1, M1, C4, L1, and C2 (see Figure 5). If  $V_{\text{BST}}\text{-}V_{\text{SW}}$  exceeds 5 V, U1 regulates M1 to maintain a 5 V voltage across C4.

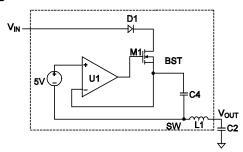


Figure 5—Internal bootstrap charging circuit

#### Start-Up and Shutdown

If both  $V_{\text{IN}}$  and  $V_{\text{EN}}$  exceed their respective thresholds, the chip starts up. The reference block starts first, generating a stable reference voltage, and then the internal regulator is enabled. The regulator provides a stable supply for the remaining circuitries.

Three events can shut down the chip:  $V_{\text{IN}}$  low,  $V_{\text{EN}}$  low, and thermal shutdown. During the shutdown procedure, the signaling path is blocked first to avoid any fault triggering. The COMP voltage and the internal supply rail are then pulled down. The floating driver is not subject to this shutdown command.

#### **Additional RC Snubber Circuit**

An additional RC snubber circuit can clamp the voltage spike and damp the ringing voltage for better EMI performance.

The power dissipation of the RC snubber circuit is estimated using Equation (1):

$$P_{Loss} = f_S \times C_S \times V_{IN}^2 \tag{1}$$

Where  $f_S$  is the switching frequency,  $C_s$  is the snubber capacitor, and  $V_{IN}$  is the input voltage.

For improved efficiency, the value of  $C_S$  should not be set too high. Generally, a 5.6  $\Omega$   $R_S$  and a 330 pF  $C_S$  are recommended to generate the RC snubber circuit (see Figure 6).

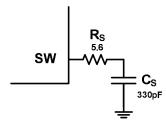


Figure 6—Additional RC snubber circuit



### **APPLICATION INFORMATION**

#### **Setting the Output Voltage**

The external resistor divider sets the output voltage (see "Typical Application" on page 1). Choose R1 (see Table 1); R2 is then given by Equation (2):

$$R2 = \frac{R1}{\frac{V_{\text{out}}}{0.798V} - 1}$$
 (2)

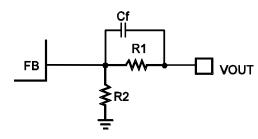


Figure 7—Feedback network

See Table 1 and Figure 7 for the feedback network and a list of recommended feedback network parameters for common output voltages.

Table 1—Recommended parameters for common output voltages

|                     | Small solution size(C <sub>IN</sub> =10μF/0805/25V,<br>C <sub>OUT</sub> =22 μF/0805/16 V) |            |            |                        |   |   |  |            | Low V <sub>OUT</sub> ripple(C <sub>IN</sub> =10 μF/0805/25 V,<br>C <sub>OUT</sub> =2X22 μF/0805/16 V) |                        |   |   |  |
|---------------------|---|------------|------------|------------------------|---|---|--|------------|---|------------------------|---|---|--|
| V <sub>IN</sub> (V) | V <sub>OUT</sub> (V)  | R1<br>(kΩ) | R2<br>(kΩ) | C <sub>f</sub><br>(pF) | V <sub>OUT</sub><br>ripple<br>(mV) <sup>(9)</sup> | Load<br>transient<br>(mV) <sup>(10)</sup> |  | R1<br>(kΩ) | R2<br>(kΩ)  | C <sub>f</sub><br>(pF) | V <sub>OUT</sub><br>ripple<br>(mV) <sup>(9)</sup> | Load<br>transient<br>(mV) <sup>(10)</sup> |  |
|                     | 5   | 130        | 24.9       | NS                     | 19.2  | 162                                       |  | 56         | 10.7  | NS                     | 10.4  | 103                                       |  |
| 24                  | 3.3   | 120        | 38.3       | NS                     | 13.6  | 127                                       |  | 75         | 24  | NS                     | 7.6   | 86  |  |
|                     | 2.5   | 102        | 47.5       | 5.6                    | 10.8  | 94  |  | 62         | 29.4  | 5.6                    | 5.8   | 58  |  |
|                     | 5   | 115        | 22         | NS                     | 17.6  | 157                                       |  | 40.2       | 7.68  | NS                     | 9.4   | 93  |  |
| 21                  | 3.3   | 102        | 32.4       | NS                     | 12.4  | 115                                       |  | 62         | 19.6  | NS                     | 7   | 83  |  |
|                     | 2.5   | 102        | 47.5       | 5.6                    | 10  | 87  |  | 62         | 29.4  | 5.6                    | 5.2   | 60  |  |
|                     | 5   | 115        | 22         | NS                     | 16.4  | 159                                       |  | 40.2       | 7.68  | NS                     | 8.8   | 93  |  |
| 19                  | 3.3   | 102        | 32.4       | NS                     | 11.4  | 119                                       |  | 62         | 19.6  | NS                     | 6.6   | 86  |  |
|                     | 2.5   | 102        | 47.5       | 5.6                    | 9.8   | 91  |  | 62         | 29.4  | 5.6                    | 5   | 64  |  |
|                     | 5   | 115        | 22         | NS                     | 15.6  | 159                                       |  | 40.2       | 7.68  | NS                     | 7.8   | 89  |  |
| 16                  | 3.3   | 102        | 32.4       | NS                     | 10.6  | 123                                       |  | 62         | 19.6  | NS                     | 6   | 90  |  |
| 10                  | 2.5   | 102        | 47.5       | 5.6                    | 9.6   | 94  |  | 62         | 29.4  | 5.6                    | 4.8   | 68  |  |
|                     | 1.8   | 102        | 82         | 5.6                    | 8.6   | 71  |  | 62         | 49.9  | 5.6                    | 4   | 53  |  |
|                     | 5   | 115        | 22         | NS                     | 14.8  | 158                                       |  | 40.2       | 7.68  | NS                     | 7.4   | 91  |  |
|                     | 3.3   | 102        | 32.4       | NS                     | 10.2  | 126                                       |  | 40.2       | 12.7  | NS                     | 5.6   | 71  |  |
| 14                  | 2.5   | 75         | 34.8       | 5.6                    | 9.4   | 82  |  | 40.2       | 18.7  | 5.6                    | 4.6   | 58  |  |
|                     | 1.8   | 102        | 82         | 5.6                    | 8.4   | 81  |  | 62         | 49.9  | 5.6                    | 4.2   | 59  |  |
|                     | 1.5 <sup>(11)</sup>   | 158        | 180        | 5.6                    | 7.2   | 89  |  | 62         | 69.8  | 5.6                    | 3.6   | 56  |  |
|                     | 5   | 100        | 19.1       | NS                     | 13.8  | 141                                       |  | 34         | 6.49  | NS                     | 6.4   | 87  |  |
|                     | 3.3   | 75         | 24         | NS                     | 9.4   | 110                                       |  | 40.2       | 12.7  | NS                     | 5.2   | 70  |  |
| 12                  | 2.5   | 75         | 34.8       | 5.6                    | 9   | 86  |  | 40.2       | 18.7  | 5.6                    | 4.4   | 60  |  |
| '-                  | 1.8   | 102        | 82         | 5.6                    | 7.8   | 85  |  | 47         | 37.4  | 5.6                    | 4   | 54  |  |
|                     | 1.5 <sup>(11)</sup>   | 158        | 180        | 5.6                    | 6.6   | 109                                       |  | 47         | 53.6  | 5.6                    | 3.4   | 50  |  |
|                     | 1.2 <sup>(11)</sup>   | 158        | 316        | 5.6                    | 6.2   | 105                                       |  | 75         | 147   | 5.6                    | 3   | 66  |  |



|                        | Small Solution Size(C <sub>IN</sub> =10μF/0805/25V,<br>C <sub>OUT</sub> =22μF/0805/16V) |            |            |                        |   |   |  |            |            |                        | C <sub>IN</sub> =10μF/0<br>ιF/0805/16             |   |
|------------------------|---|------------|------------|------------------------|---|---|--|------------|------------|------------------------|---|---|
| V <sub>IN</sub><br>(V) | V <sub>оит</sub> (V)  | R1<br>(kΩ) | R2<br>(kΩ) | C <sub>f</sub><br>(pF) | V <sub>OUT</sub><br>ripple<br>(mV) <sup>(9)</sup> | Load<br>transient<br>(mV) <sup>(10)</sup> |  | R1<br>(kΩ) | R2<br>(kΩ) | C <sub>f</sub><br>(pF) | V <sub>OUT</sub><br>ripple<br>(mV) <sup>(9)</sup> | Load<br>transient<br>(mV) <sup>(10)</sup> |
|                        | 5   | 100        | 19.1       | NS                     | 13.2  | 141                                       |  | 34         | 6.49       | NS                     | 6.2   | 82  |
|                        | 3.3   | 75         | 24         | NS                     | 8.4   | 104                                       |  | 40.2       | 12.7       | NS                     | 4.8   | 68  |
|                        | 2.5   | 75         | 34.8       | 5.6                    | 8.2   | 87  |  | 40.2       | 18.7       | 5.6                    | 4   | 60  |
| 10                     | 1.8   | 75         | 59         | 5.6                    | 7.2   | 73  |  | 47         | 37.4       | 5.6                    | 3.6   | 56  |
|                        | 1.5   | 102        | 115        | 5.6                    | 6   | 87  |  | 47         | 53.6       | 5.6                    | 3.2   | 52  |
|                        | 1.2 <sup>(11)</sup>   | 102        | 205        | 5.6                    | 5.4   | 85  |  | 62         | 124        | 5.6                    | 2.8   | 59  |
|                        | 1 <sup>(11)</sup>   | 102        | 402        | 5.6                    | 4.8   | 82  |  | 82         | 324        | 5.6                    | 2.6   | 70  |
|                        | 5   | 100        | 19.1       | NS                     | 9.2   | 140                                       |  | 34         | 6.49       | NS                     | 5   | 86  |
|                        | 3.3   | 75         | 24         | NS                     | 7.6   | 103                                       |  | 40.2       | 12.7       | NS                     | 3.8   | 72  |
|                        | 2.5   | 75         | 34.8       | 5.6                    | 7   | 87  |  | 40.2       | 18.7       | 5.6                    | 3.4   | 60  |
| 8                      | 1.8   | 75         | 59         | 5.6                    | 6.4   | 76  |  | 47         | 37.4       | 5.6                    | 3   | 58  |
|                        | 1.5   | 75         | 84.5       | 5.6                    | 5.4   | 75  |  | 47         | 53.6       | 5.6                    | 2.8   | 53  |
|                        | 1.2 <sup>(11)</sup>   | 75         | 147        | 5.6                    | 5   | 69  |  | 47         | 93.1       | 5.6                    | 2.6   | 50  |
|                        | 1 <sup>(11)</sup>   | 75         | 294        | 5.6                    | 4.6   | 65  |  | 56         | 221        | 5.6                    | 2.2   | 52  |
|                        | 3.3   | 75         | 24         | NS                     | 6   | 104                                       |  | 40.2       | 12.7       | NS                     | 3.4   | 74  |
|                        | 2.5   | 75         | 34.8       | 5.6                    | 5.8   | 91  |  | 40.2       | 18.7       | 5.6                    | 3.2   | 60  |
| 5                      | 1.8   | 75         | 59         | 5.6                    | 5.2   | 86  |  | 47         | 37.4       | 5.6                    | 2.8   | 58  |
| 5                      | 1.5   | 62         | 69.8       | 5.6                    | 5   | 73  |  | 47         | 53.6       | 5.6                    | 2.4   | 56  |
|                        | 1.2 <sup>(11)</sup>   | 62         | 124        | 5.6                    | 4.6   | 67  |  | 47         | 93.1       | 5.6                    | 2.2   | 53  |
|                        | 1 <sup>(11)</sup>   | 62         | 243        | 5.6                    | 4.4   | 66  |  | 47         | 187        | 5.6                    | 2   | 50  |

Table 1—Recommended parameters for common output voltages (continued)

#### NOTES:

Normally, it is recommended to set the output voltage from 0.8 V to 5.5 V. However, it can be set higher than 5.5 V. In this case, the output voltage ripple is larger due to a larger inductor ripple current. An additional output capacitor is needed to reduce the output ripple voltage.

If output voltage is high, heat dissipation becomes more important. Please refer to the "PCB Layout Guidelines" section on page 19 to achieve better thermal performance.

For thermal consideration, the relationship curve between the output voltage and the maximum output current is shown in Figure 8.

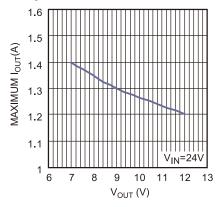


Figure 8—Maximum output current vs. output voltage

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<sup>9)</sup> V<sub>OUT</sub> PWM ripple is tested when Io=2 A.

<sup>10)</sup> Load transient from 1 A to 2 A, slew rate =0.8 A/µs.

<sup>11)</sup> In these specs, BST operation current will charge the output voltage higher than the setting value when there is no load, due to a large resistor divider value. A 10 μA load current can pull the output voltage up to a normal regulation level.



#### **Selecting the Input Capacitor**

The input current to the step-down converter is and therefore requires discontinuous. capacitor to supply the AC current while maintaining the DC input voltage. Use low ESR capacitors for improved performance. Use ceramic capacitors with X5R or X7R dielectrics for optimum results because of their low ESR and small temperature coefficients. For most applications, use a 10 µF capacitor.

Since C1 absorbs the input switching current, it requires an adequate ripple-current rating. The RMS current in the input capacitor is estimated with Equation (3):

$$I_{C1} = I_{LOAD} \times \sqrt{\frac{V_{OUT}}{V_{IN}}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$
 (3)

The worst case condition occurs at  $V_{IN} = 2 V_{OUT}$ , where:

$$I_{C1} = \frac{I_{LOAD}}{2}$$

For simplification, choose an input capacitor with an RMS current rating greater than half of the maximum load current.

The input capacitor can be electrolytic, tantalum, or ceramic. When using electrolytic or tantalum capacitors, add a small, high-quality ceramic capacitor (e.g. 0.1 µF) placed as close to the IC as possible. When using ceramic capacitors, make sure they have enough capacitance to provide sufficient charge to prevent excessive voltage ripple at the input. The input voltage ripple caused by capacitance can be estimated using Equation (4):

$$\Delta V_{IN} = \frac{I_{LOAD}}{f_{s} \times C1} \times \frac{V_{OUT}}{V_{IN}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$
(4)

#### **Selecting the Output Capacitor**

The output capacitor (C2) maintains the DC output voltage. Use ceramic, tantalum, or low ESR electrolytic capacitors. For best results, use low ESR capacitors to keep the output voltage ripple low. The output voltage ripple is estimated using Equation (5):

$$\Delta V_{\text{OUT}} = \frac{V_{\text{OUT}}}{f_{\text{S}} \times L_{1}} \times \left(1 - \frac{V_{\text{OUT}}}{V_{\text{IN}}}\right) \times \left(R_{\text{ESR}} + \frac{1}{8 \times f_{\text{S}} \times C2}\right)$$
 (5)

Where  $L_1$  is the inductor value,  $R_{ESR}$  is the equivalent series resistance (ESR) value of the output capacitor, and L₁=1 µH.

For ceramic capacitors, the capacitance dominates the impedance at the switching frequency; the capacitance causes the majority of the output voltage ripple. For simplification, the output voltage ripple is estimated using Equation (6):

$$\Delta V_{\text{OUT}} = \frac{V_{\text{OUT}}}{8 \times f_{\text{S}}^2 \times L_1 \times C2} \times \left(1 - \frac{V_{\text{OUT}}}{V_{\text{IN}}}\right)$$
 (6)

For tantalum or electrolytic capacitors, the ESR dominates the impedance at the switching frequency. For simplification, the output ripple is approximated using Equation (7):

$$\Delta V_{\text{OUT}} = \frac{V_{\text{OUT}}}{f_{\text{s}} \times L_{\text{1}}} \times \left(1 - \frac{V_{\text{OUT}}}{V_{\text{IN}}}\right) \times R_{\text{ESR}}$$
 (7)

The characteristics of the output capacitor affect the stability of the regulation system. The MPM3620A internal compensation is optimized for a wide range of capacitance and ESR values.

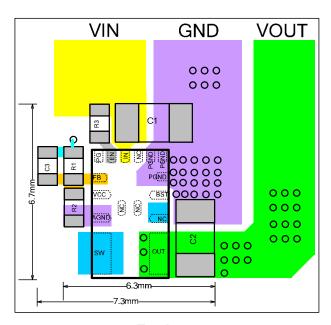
### PCB Lavout Guidelines<sup>(12)</sup>

Efficient PCB layout is critical to achieve stable operation, particularly for input capacitor placement. For best results, refer to Figure 9 and follow the guidelines below:

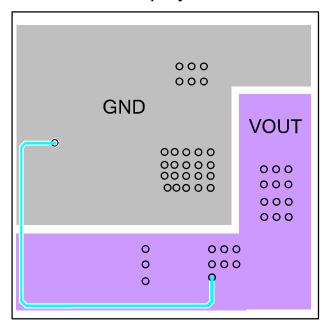
- Use a large ground plane to connect directly to PGND. Add vias near PGND if the bottom layer is ground plane.
- The high-current paths (PGND, IN, and OUT) should have short, direct, and wide traces. Place the ceramic input capacitor close to IN and PGND. Keep the input capacitor and IN connection as short and wide as possible.
- Place the external feedback resistors next to FB.
- 4. Keep the feedback network away from the switching node.

#### NOTES:

12) The recommended layout is based on the "Typical Application Circuits" section on page 21.



**Top Layer** 



**Bottom Layer** 

Figure 9—Recommended PCB layout

#### **Design Example**

Table 2 shows a design example following the application guidelines for the specifications below:

Table 2—Design example

| V <sub>IN</sub>  | 12 V  |
|------------------|-------|
| V <sub>out</sub> | 3.3 V |
| I <sub>out</sub> | 2 A   |

The detailed application schematic is shown in Figure 11. The typical performance and circuit waveforms are shown in the "Typical Characteristics" section (For additional device applications, please refer to the related evaluation board datasheets).



## TYPICAL APPLICATION CIRCUITS (13)(14)

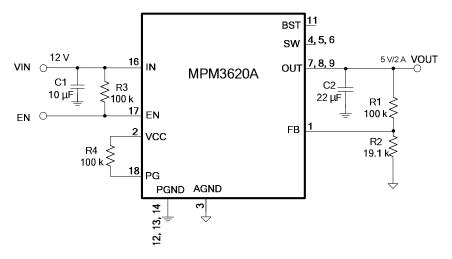


Figure 10-Vo=5 V, lo=2 A

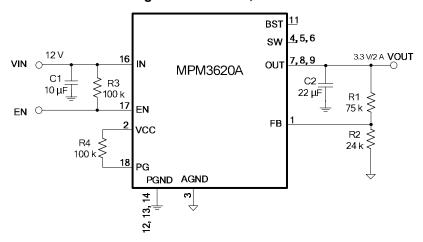


Figure 11-Vo=3.3 V, lo=2 A

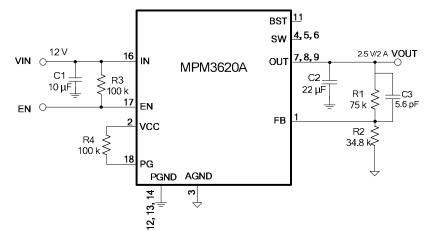


Figure 12-Vo=2.5 V, Io=2 A



## TYPICAL APPLICATION CIRCUITS (continued)

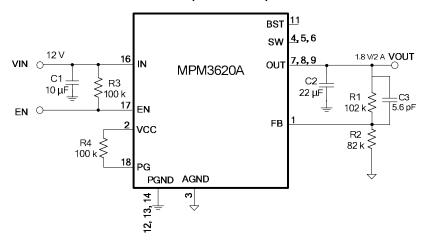


Figure 13-Vo=1.8 V, lo=2 A

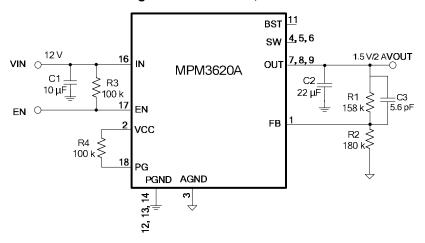


Figure 14—Vo=1.5 V, lo=2 A

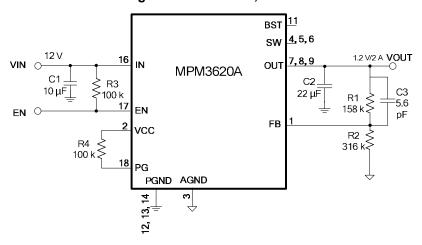


Figure 15—Vo=1.2 V, Io=2 A

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## TYPICAL APPLICATION CIRCUITS (continued)

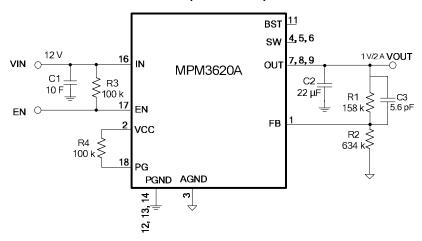


Figure 16—Vo=1 V, Io=2 A

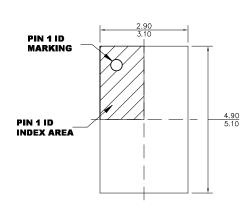
#### NOTES:

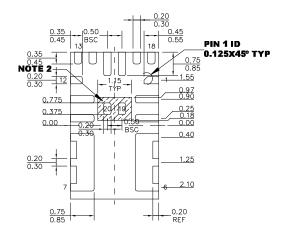
- 13) In 12 V<sub>IN</sub> to 1 V<sub>OUT</sub> application conditions, the HS-FET's on-time is close to the minimum on-time; although the SW may have a little jitter, the output voltage ripple is smaller than 15 mV in PWM mode.
- 14) In 12  $V_{IN}$  to 1.5/1.2/1  $V_{OUT}$  application conditions, BST operation current will charge the output voltage higher than the setting value when there is completely no load, due to a large resistor divider value. A 10  $\mu$ A load current is able to pull the output voltage up to a normal regulation level.

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#### PACKAGE INFORMATION

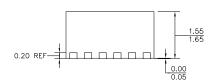
#### QFN-20 (3mm x 5mm x 1.6mm)



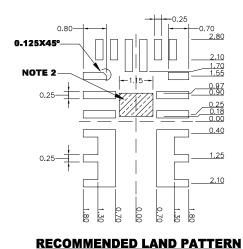


**TOP VIEW** 

**BOTTOM VIEW** 



**SIDE VIEW** 



#### **NOTE:**

- 1) ALL DIMENSIONS ARE IN MILLIMETERS.
- 2) SHADED AREA IS THE KEEP-OUT ZONE. ANY PCB METAL TRACE AND VIA ARE NOT ALLOWED TO **CONNECT TO THIS AREA ELECTRICALLY OR** MECHANICALLY.
- 3) LEAD COPLANARITY SHALL BE 0.10 MILLIMETERS MAX.
- 4) JEDEC REFERENCE IS MO-220.
- 5) DRAWING IS NOT TO SCALE.

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